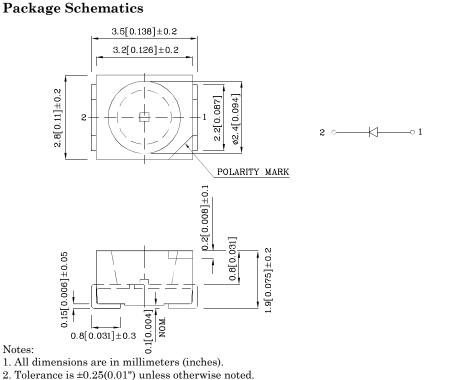


# Part Number: XZM2CYK45WT

3.5x2.8mm PLCC2 SMD LED

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  RoHS compliant





3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Yellow (AlGaInP)	Unit	
Reverse Voltage	$V_{\mathrm{R}}$	5	V	
Forward Current		50	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	140	mA	
Power Dissipation	$P_{D}$	125	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	-C	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T <sub>A</sub> =25°C)	Yellow (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λΡ	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle \lambda$	20	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	45	pF

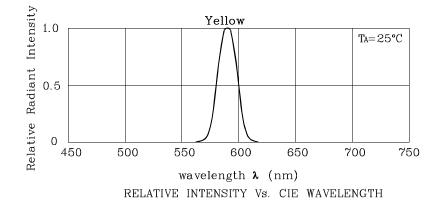
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZM2CYK45WT	Yellow	AlGaInP	Water Clear	200*	447*	590*	120°

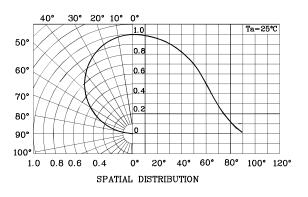
\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Mar 29,2016

XDSB8256 V1-Z Layout: Maggie L.







✤ Yellow

50

40

30

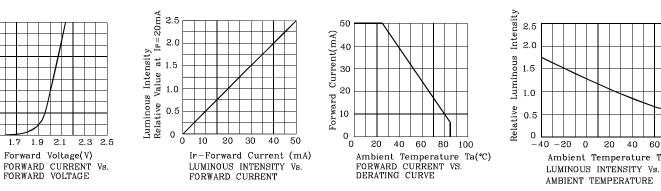
20

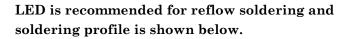
10

0

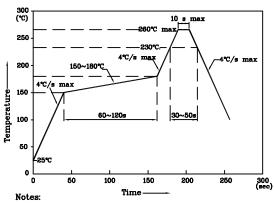
1.5

Forward Current(mA)





80 60 Ambient Temperature Ta(°C)



Reflow Soldering Profile for SMD Products (Pb-Free Components)

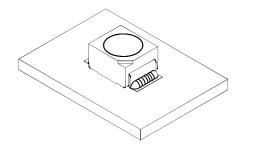
1. Maximum soldering temperature should not exceed 260°C 2.

Recommended reflow temperature: 145°C-260°C Do not put stress to the epoxy resin during З.

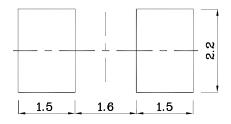
high temperatures conditions



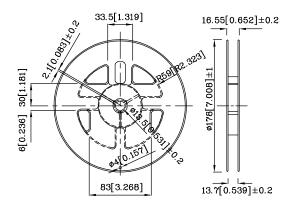
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



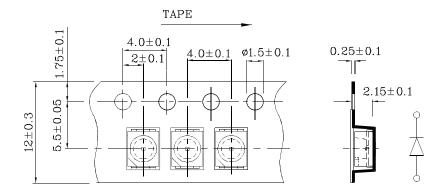
#### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



# Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

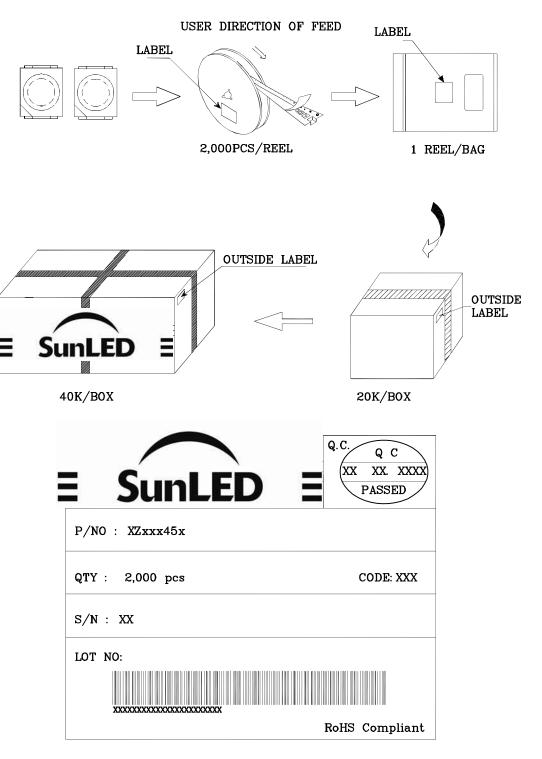
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

Mar 29,2016



### **PACKING & LABEL SPECIFICATIONS**



#### TERMS OF USE

1. Data presented in this document reflect statistical figures and should be treated as technical reference only.

- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
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- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp